## SN74AVC2T245 Dual-Bit Dual-Supply Bus Transceiver with Configurable Level-Shifting / Voltage Translation and Tri-State Outputs

## 1 Features

- Each Channel Has Independent Direction Control
- Control Inputs $\mathrm{V}_{\mathrm{IH}} / \mathrm{V}_{\mathrm{IL}}$ Levels Are Referenced to $\mathrm{V}_{\mathrm{CCA}}$ Voltage
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.2 V to 3.6 V Power-Supply Range
- I/Os Are 4.6 V Tolerant
- $\mathrm{I}_{\text {off }}$ Supports Partial-Power-Down Mode Operation
- $\mathrm{V}_{\mathrm{CC}}$ Isolation Feature - If Either $\mathrm{V}_{\mathrm{CC}}$ Input is at GND, Both Ports are in High-Impedance State
- Typical Data Rates
- 500 Mbps ( 1.8 V to 3.3 V Level-Shifting)
- 320 Mbps ( $<1.8 \mathrm{~V}$ to 3.3 V Level-Shifting)
- 320 Mbps (Translate to 2.5 V or 1.8 V )
- 280 Mbps (Translate to 1.5 V )
- 240 Mbps (Translate to 1.2 V )
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
- 5000 V Human-Body Model (A114-A)
- 200 V Machine Model (A115-A)
- 1500 V Charged-Device Model (C101)


## 2 Applications

- Personal Electronics
- Industrial
- Enterprise
- Telecom


## Logic Diagram (Positive Logic)


(1) Shown for a single channel

## 3 Description

This dual-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track $\mathrm{V}_{\text {CCA }}$. $\mathrm{V}_{\text {CCA }}$ accepts any supply voltage from 1.2 V to 3.6 V . The B port is designed to track $\mathrm{V}_{\text {CCB }} . \mathrm{V}_{\text {CCB }}$ accepts any supply voltage from 1.2 V to 3.6 V . This allows for universal low-voltage bidirectional translation between any of the $1.2 \mathrm{~V}, 1.5$ $\mathrm{V}, 1.8 \mathrm{~V}, 2.5 \mathrm{~V}$, and 3.3 V voltage nodes.

The SN74AVC2T245 is designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR) input and the output-enable ( $\overline{\mathrm{OE}})$ activate either the B-port outputs or the A-port outputs or place both output ports into the high-impedance mode. The device transmits data from the A bus to the B bus when the B -port outputs are activated and from the $B$ bus to the $A$ bus when the A-port outputs are activated. The input circuitry on both A and B ports always is active and must have a logic HIGH or LOW level applied to prevent excess $\mathrm{I}_{\mathrm{CC}}$ and $\mathrm{I}_{\mathrm{CCZ}}$.

The SN74AVC2T245 control pins (DIR1, DIR2, and $\overline{\mathrm{OE}})$ are supplied by $\mathrm{V}_{\mathrm{CCA}}$.
This device is fully specified for partial-power-down applications using $\mathrm{I}_{\text {off }}$. The $\mathrm{I}_{\text {off }}$ circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.
The $\mathrm{V}_{\mathrm{CC}}$ isolation feature ensures that if either $\mathrm{V}_{\mathrm{CC}}$ input is at GND, both ports are in the high-impedance state.

To ensure the high-impedance state during power up or power down, $\overline{\mathrm{OE}}$ must be connected to $\mathrm{V}_{\mathrm{cc}}$ through a pull-up resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Device Information ${ }^{(1)}$

| PART NUMBER | PACKAGE | BODY SIZE (NOM) |
| :--- | :--- | :---: |
| SN74AVC2T245 | UQFN $(10)$ | $1.80 \mathrm{~mm} \times 1.40 \mathrm{~mm}$ |

(1) For all available packages, see the orderable addendum at the end of the datasheet.

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## 4 Revision History

Changes from Revision C (July 2015) to Revision D Page

- Made changes to Pin Configuration and Functions ..... 1
Changes from Revision B (June 2015) to Revision C Page
- The Ordering Information table (formally on page 1) contained a Top-Side Marking of TQ_. The table has been replaced with the Package Option Addendum in Mechanical, Packaging, and Orderable Information. VC_ was added to the device marking ..... 17
Changes from Revision A (May 2012) to Revision B Page
- Added Pin Configuration and Functions section, ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section ..... 1
- Removed the Ordering Information table. ..... 1


## 5 Pin Configuration and Functions



Pin Functions

| PIN |  | DESCRIPTION |
| :---: | :---: | :---: |
| NAME | NO. (UQFN) |  |
| $\mathrm{V}_{\text {CCA }}$ | 7 | Supply Voltage A |
| $V_{\text {CCB }}$ | 6 | Supply Voltage B |
| GND | 3 | Ground |
| A1 | 8 | Output or input depending on state of DIR. Output level depends on $\mathrm{V}_{\text {CCA }}$. |
| A2 | 9 | Output or input depending on state of DIR. Output level depends on $\mathrm{V}_{\text {CCA }}$. |
| B1 | 5 | Output or input depending on state of DIR. Output level depends on $\mathrm{V}_{\text {CCB }}$. |
| B2 | 4 | Output or input depending on state of DIR. Output level depends on $\mathrm{V}_{\text {CCB }}$. |
| DIR1,DIR2 | 10,1 | Direction Pin, Connect to GND or to $\mathrm{V}_{\text {CCA }}$ |
| $\overline{\mathrm{OE}}$ | 2 | Tri-state output-mode enables. Pull OE high to place all outputs in 3-state mode. Referenced to $\mathrm{V}_{\mathrm{CCA}}$ |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) ${ }^{(1)}$

|  |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| Supply voltage |  | -0.5 | 4.6 | V |
| Input voltage ${ }^{(2)}$ | I/O ports (A port) | -0.5 | 4.6 | V |
|  | I/O ports (B port) | -0.5 | 4.6 |  |
|  | Control inputs | -0.5 | 4.6 |  |
| Voltage applied to any output in the high-impedance or power-off state ${ }^{(2)}$ | A port | -0.5 | 4.6 | V |
|  | B port | -0.5 | 4.6 |  |
| Voltage applied to any output in the high or low state ${ }^{(2)(3)}$ | A port | -0.5 | $\mathrm{V}_{\text {CCA }}+0.5$ | V |
|  | B port | -0.5 | $\mathrm{V}_{C C B}+0.5$ |  |
| $\mathrm{I}_{\mathrm{K}} \quad$ Input clamp current | $\mathrm{V}_{1}<0$ |  | -50 | mA |
| IOK Output clamp current | $\mathrm{V}_{\mathrm{O}}<0$ |  | -50 | mA |
| Continuous output current |  |  | $\pm 50$ | mA |
| Continuous current through $\mathrm{V}_{\mathrm{CCA}}, \mathrm{V}_{\mathrm{CCB}}$, or GND |  |  | $\pm 100$ | mA |
| $\mathrm{T}_{\mathrm{J}} \quad$ Junction Temperature |  | -40 | 150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ Storage temperature range |  | -65 | 150 | ${ }^{\circ} \mathrm{C}$ |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
(3) The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.

### 6.2 ESD Ratings

|  |  | VALUE | UNIT |
| :---: | :---: | :---: | :---: |
| Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 ${ }^{(1)}$ | 5000 | V |
|  | Charged-device model (CDM), per JEDEC specification JESD22C101 ${ }^{(2)}$ | 1500 |  |

(1) JEDEC document JEP155 states that 500 V HBM allows safe manufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 250 V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions ${ }^{(1)(2)(3)}$

|  |  |  | $\mathrm{V}_{\mathrm{ClI}}$ | $\mathrm{V}_{\text {cco }}$ | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {CCA }}$ | Supply voltage |  |  |  | 1.2 | 3.6 | V |
| $\mathrm{V}_{\text {CCB }}$ | Supply voltage |  |  |  | 1.2 | 3.6 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage | Data inputs ${ }^{(1)}$ | 1.2 V to 1.95 V |  | $\mathrm{V}_{\mathrm{CCI}} \times 0.65$ |  | V |
|  |  |  | 1.95 V to 2.7 V |  | 1.6 |  |  |
|  |  |  | 2.7 V to 3.6 V |  | 2 |  |  |
| $\mathrm{V}_{\text {IL }}$ | Low-level input voltage | Data inputs ${ }^{(1)}$ | 1.2 V to 1.95 V |  |  | 0.35 | V |
|  |  |  | 1.95 V to 2.7 V |  |  | 0.7 |  |
|  |  |  | 2.7 V to 3.6 V |  |  | 0.8 |  |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage | DIR (referenced to $\left.\mathrm{V}_{\mathrm{CCA}}\right)^{(2)}$ | 1.2 V to 1.95 V |  | $\mathrm{V}_{\text {CCA }} \times 0.65$ |  | V |
|  |  |  | 1.95 V to 2.7 V |  | 1.6 |  |  |
|  |  |  | 2.7 V to 3.6 V |  | 2 |  |  |

(1) $V_{C C I}$ is the $V_{C C}$ associated with the input port.
(2) $V_{C C O}$ is the $V_{C C}$ associated with the output port.
(3) All unused data inputs of the device must be held at $\mathrm{V}_{\mathrm{CCI}}$ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

Recommended Operating Conditions ${ }^{(1)(2)(3)}$ (continued)

|  |  |  | $\mathrm{V}_{\text {cli }}$ | $\mathrm{V}_{\text {cco }}$ | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {IL }}$ | Low-level input voltage | DIR <br> (referenced to $\left.\mathrm{V}_{\mathrm{CCA}}\right)^{(2)}$ | 1.2 V to 1.95 V |  | $\mathrm{V}_{\text {CCA }} \times 0.35$ |  | V |
|  |  |  | 1.95 V to 2.7 V |  |  | 0.7 |  |
|  |  |  | 2.7 V to 3.6 V |  |  | 0.8 |  |
| $\mathrm{V}_{1}$ | Input voltage |  |  |  | 0 | 3.6 | V |
| $\mathrm{V}_{\mathrm{O}}$ | Output voltage | Active state |  |  | 0 | $\mathrm{V}_{\mathrm{CCO}}$ | V |
|  |  | 3-state |  |  | 0 | 3.6 |  |
| IOH | High-level output current |  |  | 1.1 V to 1.2 V |  | -3 | mA |
|  |  |  |  | 1.4 V to 1.6 V |  | -6 |  |
|  |  |  |  | 1.65 V to 1.95 V | -8 |  |  |
|  |  |  |  | 2.3 V to 2.7 V |  | -9 |  |
|  |  |  |  | 3 V to 3.6 V |  | -12 |  |
| IOL | Low-level output current |  |  | 1.1 V to 1.2 V |  | 3 | mA |
|  |  |  |  | 1.4 V to 1.6 V |  | 6 |  |
|  |  |  |  | 1.65 V to 1.95 V |  | 8 |  |
|  |  |  |  | 2.3 V to 2.7 V |  | 9 |  |
|  |  |  |  | 3 V to 3.6 V |  | 12 |  |
| $\Delta t / \Delta v$ | Input transition rise or fall rate |  |  |  |  | 5 | ns/V |
| $\mathrm{T}_{\mathrm{A}}$ | Operating free-air temperature |  |  |  | -40 | 85 | ${ }^{\circ} \mathrm{C}$ |

### 6.4 Thermal Information

| THERMAL METRIC ${ }^{(1)}$ |  | SN74AVC2T245 | UNIT |
| :---: | :---: | :---: | :---: |
|  |  | RSW (UQFN) |  |
|  |  | 10 PINS |  |
| $\mathrm{R}_{\text {өJA }}$ | Junction-to-ambient thermal resistance | 109.1 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\text {өJC(top) }}$ | Junction-to-case (top) thermal resistance | 57.9 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\text {өJB }}$ | Junction-to-board thermal resistance | 57.0 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\psi$ JT | Junction-to-top characterization parameter | 2.7 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\psi_{\mathrm{JB}}$ | Junction-to-board characterization parameter | 57.0 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\text {өJC(bot) }}$ | Junction-to-case (bottom) thermal resistance | 18.4 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

[^0]
### 6.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted) ${ }^{(1)(2)}$

| PARAMETER |  | TEST CONDITIONS |  | $\mathrm{V}_{\text {cca }}$ | $\mathrm{V}_{\text {ccB }}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP |  |  | MAX | MIN | MAX |  |
| $\mathrm{V}_{\mathrm{OH}}$ |  |  |  | $\mathrm{IOH}^{\prime}=-100 \mu \mathrm{~A}$ | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ | 1.2 V to 3.6 V | 1.2 V to 3.6 V |  |  |  | $\mathrm{V}_{\mathrm{CCO}}-0.2$ |  | V |
|  |  | $\mathrm{I}_{\mathrm{OH}}=-3 \mathrm{~mA}$ | 1.2 V | 1.2 V |  |  | 0.95 |  |  |  |  |  |
|  |  | $\mathrm{IOH}=-6 \mathrm{~mA}$ | 1.4 V | 1.4 V |  |  |  |  | 1.05 |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{OH}}=-8 \mathrm{~mA}$ | 1.65 V | 1.65 V |  |  |  |  | 1.2 |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{OH}}=-9 \mathrm{~mA}$ | 2.3 V | 2.3 V |  |  |  |  | 1.75 |  |  |  |
|  |  | $\mathrm{IOH}=-12 \mathrm{~mA}$ | 3 V | 3 V |  |  |  |  | 2.3 |  |  |  |
| $\mathrm{V}_{\text {OL }}$ |  | $\mathrm{loL}=100 \mu \mathrm{~A}$ | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IL}}$ | 1.2 V to 3.6 V | 1.2 V to 3.6 V |  |  |  |  | 0.2 | V |  |
|  |  | $\mathrm{l}_{\mathrm{OL}}=3 \mathrm{~mA}$ |  | 1.2 V | 1.2 V |  | 0.25 |  |  |  |  |  |
|  |  | $\mathrm{l}_{\mathrm{OL}}=6 \mathrm{~mA}$ |  | 1.4 V | 1.4 V |  |  |  |  | 0.35 |  |  |
|  |  | $\mathrm{l}_{\mathrm{OL}}=8 \mathrm{~mA}$ |  | 1.65 V | 1.65 V |  |  |  |  | 0.45 |  |  |
|  |  | $\mathrm{I}_{\mathrm{OL}}=9 \mathrm{~mA}$ |  | 2.3 V | 2.3 V |  |  |  |  | 0.55 |  |  |
|  |  | $\mathrm{IOL}=12 \mathrm{~mA}$ |  | 3 V | 3 V |  |  |  |  | 0.7 |  |  |
| 1 | Control inputs | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {CCA }}$ or G |  | 1.2 V to 3.6 V | 1.2 V to 3.6 V |  | $\pm 0.025$ | $\pm 0.25$ |  | $\pm 1$ | $\mu \mathrm{A}$ |  |
| $\mathrm{I}_{\text {fff }}$ | A or B port | $\mathrm{V}_{1}$ or $\mathrm{V}_{\mathrm{O}}=0$ to 3.6 V |  | 0 V | 0 V to 3.6 V |  | $\pm 0.1$ | $\pm 1$ |  | $\pm 5$ | $\mu \mathrm{A}$ |  |
|  |  |  |  | 0 V to 3.6 V | 0 V |  | $\pm 0.1$ | $\pm 1$ |  | $\pm 5$ |  |  |
| l Oz | A or B port | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CCO}} \text { or } \\ & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CCI}} \text { or } \mathrm{GI} \end{aligned}$ | $\overline{O E}=V_{I H}$ | 3.6 V | 3.6 V |  | $\pm 0.5$ | $\pm 2.5$ |  | $\pm 5$ | $\mu \mathrm{A}$ |  |
| ICCA |  | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {CCI }}$ or GND, $\mathrm{l}^{\prime}=0$ |  | 1.2 V to 3.6 V | 1.2 V to 3.6 V |  |  |  |  | 8 | $\mu \mathrm{A}$ |  |
|  |  | 0 V | 0 V to 3.6 V |  |  |  |  | -2 |  |  |
|  |  | 0 V to 3.6 V | 0 V |  |  |  |  | 8 |  |  |
| $\mathrm{I}_{\text {CCB }}$ |  |  |  | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {CCI }}$ or GND, $\mathrm{I}_{\mathrm{O}}=0$ |  | 1.2 V to 3.6 V | 1.2 V to 3.6 V |  |  |  |  | 8 | $\mu \mathrm{A}$ |
|  |  | 0 V | 0 V to 3.6 V |  |  |  |  |  |  | 8 |  |  |
|  |  | 0 V to 3.6 V | 0 V |  |  |  |  |  |  | -2 |  |  |
| $\mathrm{I}_{\mathrm{CCA}}+\mathrm{I}_{\text {CCB }}$ |  |  |  | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {CCI }}$ or GND, $\mathrm{I}_{\mathrm{O}}=0$ |  | 1.2 V to 3.6 V | 1.2 V to 3.6 V |  |  |  |  | 16 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{i}$ | Control inputs | $\mathrm{V}_{\mathrm{I}}=3.3 \mathrm{~V}$ or GND |  | 3.3 V | 3.3 V |  | 3.5 |  |  | 4.5 | pF |  |
| $\mathrm{C}_{\text {io }}$ | A or B port | $\mathrm{V}_{\mathrm{O}}=3.3 \mathrm{~V}$ or GND |  | 3.3 V | 3.3 V |  | 6 |  |  | 7 | pF |  |

(1) $V_{C C O}$ is the $V_{C C}$ associated with the output port.
(2) $V_{C C I}$ is the $V_{C C}$ associated with the input port.

### 6.6 Switching Characteristics: $\mathrm{V}_{\mathrm{CCA}}=1.2 \mathrm{~V}$

over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CCA}}=1.2 \mathrm{~V}$ (unless otherwise noted) (see Figure 3)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $\mathrm{V}_{\text {CCB }}=1.2 \mathrm{~V}$ | $\begin{gathered} \mathrm{V}_{\mathrm{cCB}}=1.5 \mathrm{~V} \\ \pm 0.1 \mathrm{~V} \end{gathered}$ | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=1.8 \mathrm{~V} \\ \pm 0.15 \mathrm{~V} \end{gathered}$ | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=2.5 \mathrm{~V} \\ \pm 0.2 \mathrm{~V} \end{gathered}$ | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=3.3 \mathrm{~V} \\ \pm 0.3 \mathrm{~V} \end{gathered}$ | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | TYP | TYP | TYP | TYP | TYP |  |
| $t_{\text {PLH }}$ | A | B | 2.5 | 2.1 | 1.9 | 1.9 | 1.9 | ns |
| $\mathrm{t}_{\mathrm{PHL}}$ |  |  | 2.5 | 2.1 | 1.9 | 1.9 | 1.9 |  |
| $\mathrm{t}_{\text {PLH }}$ | B | A | 2.5 | 2.2 | 2 | 1.8 | 1.7 | ns |
| $\mathrm{t}_{\text {PHL }}$ |  |  | 2.5 | 2.2 | 2 | 1.8 | 1.7 |  |
| $\mathrm{t}_{\text {PZH }}$ | $\overline{\mathrm{OE}}$ | A | 3.8 | 3.1 | 2.7 | 2.6 | 3 | ns |
| $t_{\text {PZL }}$ |  |  | 3.8 | 3.1 | 2.7 | 2.6 | 3 |  |
| $t_{\text {PZH }}$ | $\overline{\mathrm{OE}}$ | B | 3.7 | 3.7 | 3.7 | 3.7 | 3.7 | ns |
| $t_{\text {PZL }}$ |  |  | 3.7 | 3.7 | 3.7 | 3.7 | 3.7 |  |
| $\mathrm{t}_{\text {PHZ }}$ | $\overline{\mathrm{OE}}$ | A | 4.4 | 3.6 | 3.5 | 3.3 | 4.1 | ns |
| $t_{\text {PLZ }}$ |  |  | 4.4 | 3.6 | 3.5 | 3.3 | 4.1 |  |
| $\mathrm{t}_{\mathrm{PHZ}}$ | $\overline{\mathrm{OE}}$ | B | 4.2 | 4.2 | 4.3 | 4.1 | 4.2 | ns |
| $t_{\text {PLZ }}$ |  |  | 4.2 | 4.2 | 4.3 | 4.1 | 4.2 |  |

### 6.7 Switching Characteristics: $\mathrm{V}_{\mathrm{CCA}}=1.5 \mathrm{~V} \pm 0.1 \mathrm{~V}$

over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CCA}}=1.5 \mathrm{~V} \pm 0.1 \mathrm{~V}$ (see Figure 3)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $\mathrm{V}_{\mathrm{CCB}}=1.2 \mathrm{~V}$ | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=1.5 \mathrm{~V} \\ \pm 0.1 \mathrm{~V} \end{gathered}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=1.8 \mathrm{~V} \\ \pm 0.15 \mathrm{~V} \end{gathered}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=2.5 \mathrm{~V} \\ \pm 0.2 \mathrm{~V} \end{gathered}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=3.3 \mathrm{~V} \\ \pm 0.3 \mathrm{~V} \end{gathered}$ |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | TYP | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX |  |
| $\mathrm{t}_{\text {PLH }}$ | A | B | 2.2 | 0.3 | 4.4 | 0.2 | 3.9 | 0.1 | 3.6 | 0.1 | 3.9 | ns |
| $\mathrm{t}_{\text {PHL }}$ |  |  | 2.2 | 0.3 | 4.4 | 0.2 | 3.9 | 0.1 | 3.6 | 0.1 | 3.9 |  |
| tpLH | B | A | 2 | 0.6 | 5.1 | 0.4 | 4.9 | 0.2 | 4.6 | 0.1 | 4.5 | ns |
| $\mathrm{t}_{\text {PHL }}$ |  |  | 2 | 0.6 | 5.1 | 0.4 | 4.9 | 0.2 | 4.6 | 0.1 | 4.5 |  |
| tpzH | $\overline{\mathrm{OE}}$ | A | 3.4 | 1.1 | 7.1 | 0.9 | 6.2 | 0.7 | 5.5 | 0.1 | 6.4 | ns |
| $\mathrm{t}_{\text {PZL }}$ |  |  | 3.4 | 1.1 | 7.1 | 0.9 | 6.2 | 0.7 | 5.5 | 0.1 | 6.4 |  |
| $\mathrm{t}_{\text {PZH }}$ | $\overline{\mathrm{OE}}$ | B | 2.5 | 1.1 | 8.2 | 1.1 | 8.2 | 1.1 | 8.2 | 1.1 | 8.2 | ns |
| $t_{\text {PzL }}$ |  |  | 2.5 | 1.1 | 8.2 | 1.1 | 8.2 | 1.1 | 8.2 | 1.1 | 8.2 |  |
| tpHz | $\overline{\mathrm{OE}}$ | A | 4.1 | 1.2 | 7.1 | 0.8 | 6.7 | 0.4 | 5.6 | 1 | 74 | ns |
| tplz |  |  | 4.1 | 1.2 | 7.1 | 0.8 | 6.7 | 0.4 | 5.6 | 1 | 7.4 |  |
| $t_{\text {PHZ }}$ | $\overline{\mathrm{OE}}$ | B | 3.3 | 0.3 | 7.4 | 0.2 | 5.7 | 0.3 | 5.6 | 0.3 | 5.6 | ns |
| $t_{\text {PLZ }}$ |  |  | 3.3 | 0.3 | 7.4 | 0.2 | 5.7 | 0.3 | 5.6 | 0.3 | 5.6 |  |

### 6.8 Switching Characteristics: $\mathrm{V}_{\mathrm{CCA}}=1.8 \mathrm{~V} \pm 0.15 \mathrm{~V}$

over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CCA}}=1.8 \mathrm{~V} \pm 0.15 \mathrm{~V}$ (see Figure 3)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $\mathrm{V}_{\text {CCB }}=1.2 \mathrm{~V}$ | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=1.5 \mathrm{~V} \\ \pm 0.1 \mathrm{~V} \end{gathered}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=1.8 \mathrm{~V} \\ \pm 0.15 \mathrm{~V} \end{gathered}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=2.5 \mathrm{~V} \\ \pm 0.2 \mathrm{~V} \end{gathered}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=3.3 \mathrm{~V} \\ \pm 0.3 \mathrm{~V} \end{gathered}$ |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | TYP | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX |  |
| $t_{\text {PLH }}$ | A | B | 2 | 0.1 | 4.1 | 0.1 | 3.6 | 0.1 | 3.1 | 0.1 | 3.3 | ns |
| $\mathrm{t}_{\text {PHL }}$ |  |  | 2 | 0.1 | 4.1 | 0.1 | 3.6 | 0.1 | 3.1 | 0.1 | 3.3 |  |
| $\mathrm{t}_{\text {PLH }}$ | B | A | 1.9 | 0.4 | 4.3 | 0.1 | 4.1 | 0.1 | 3.8 | 0.1 | 3.7 | ns |
| $\mathrm{t}_{\text {PHL }}$ |  |  | 1.9 | 0.4 | 4.3 | 0.1 | 4.1 | 0.1 | 3.8 | 0.1 | 3.7 |  |
| $\mathrm{t}_{\text {PZH }}$ | $\overline{\mathrm{OE}}$ | A | 3.2 | 0.8 | 6.7 | 0.4 | 5.8 | 0.4 | 4.8 | 0.3 | 4.6 | ns |
| $t_{\text {PZL }}$ |  |  | 3.2 | 0.8 | 6.7 | 0.4 | 5.8 | 0.4 | 4.8 | 0.3 | 4.6 |  |
| $\mathrm{t}_{\text {PZH }}$ | $\overline{\mathrm{OE}}$ | B | 1.9 | 0.2 | 6.7 | 0.2 | 6.6 | 0.2 | 6.7 | 0.2 | 6.7 | ns |
| $t_{\text {PZL }}$ |  |  | 1.9 | 0.2 | 6.7 | 0.2 | 6.6 | 0.2 | 6.7 | 0.2 | 6.7 |  |
| $\mathrm{t}_{\text {PHZ }}$ | $\overline{O E}$ | A | 3.8 | 0.7 | 6.2 | 0.3 | 6.5 | 0.1 | 5.2 | 0.8 | 6.5 | ns |
| tPLZ |  |  | 3.8 | 0.7 | 6.2 | 0.3 | 6.5 | 0.1 | 5.2 | 0.8 | 6.5 |  |
| $\mathrm{t}_{\mathrm{PHZ}}$ | $\overline{\mathrm{OE}}$ | B | 3.4 | 0.1 | 6.8 | 0.1 | 6.8 | 0.1 | 6.7 | 0.1 | 6.7 | ns |
| $t_{\text {PLZ }}$ |  |  | 3.4 | 0.1 | 6.8 | 0.1 | 6.8 | 0.1 | 6.7 | 0.1 | 6.7 |  |

### 6.9 Switching Characteristics: $\mathrm{V}_{\mathrm{CCA}}=2.5 \mathrm{~V} \pm 0.2 \mathrm{~V}$

over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CCA}}=2.5 \mathrm{~V} \pm 0.2 \mathrm{~V}$ (see Figure 3)

| PARAMETER | FROM (INPUT) | $\begin{gathered} \text { TO } \\ \text { (OUTPUT) } \end{gathered}$ | $\mathrm{V}_{\mathrm{CCB}}=1.2 \mathrm{~V}$ | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=1.5 \mathrm{~V} \\ \pm 0.1 \mathrm{~V} \end{gathered}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=1.8 \mathrm{~V} \\ \pm 0.15 \mathrm{~V} \end{gathered}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=2.5 \mathrm{~V} \\ \pm 0.2 \mathrm{~V} \end{gathered}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=3.3 \mathrm{~V} \\ \pm 0.3 \mathrm{~V} \end{gathered}$ |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | TYP | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX |  |
| $\mathrm{t}_{\text {PLH }}$ | A | B | 1.9 | 0.1 | 3.8 | 0.1 | 3.2 | 0.1 | 2.7 | 0.1 | 2.6 | ns |
| $\mathrm{t}_{\text {PHL }}$ |  |  | 1.9 | 0.1 | 3.8 | 0.1 | 3.2 | 0.1 | 2.7 | 0.1 | 2.6 |  |
| tplh | B | A | 1.8 | 0.5 | 3.4 | 0.2 | 3.1 | 0.1 | 2.8 | 0.1 | 2.6 | ns |
| $\mathrm{t}_{\text {PHL }}$ |  |  | 1.8 | 0.5 | 3.4 | 0.2 | 3.1 | 0.1 | 2.8 | 0.1 | 2.6 |  |
| tpzH | $\overline{\mathrm{OE}}$ | A | 3.1 | 0.7 | 6.2 | 0.5 | 5.2 | 0.3 | 4.1 | 0.3 | 3.6 | ns |
| $\mathrm{t}_{\text {PZL }}$ |  |  | 3.1 | 0.7 | 6.2 | 0.5 | 5.2 | 0.3 | 4.1 | 0.3 | 3.6 |  |
| tpzH | $\overline{\mathrm{OE}}$ | B | 1.4 | 0.4 | 4.5 | 0.4 | 4.5 | 0.4 | 4.5 | 0.4 | 4.5 | ns |
| $\mathrm{t}_{\text {PZL }}$ |  |  | 1.4 | 0.4 | 4.5 | 0.4 | 4.5 | 0.4 | 4.5 | 0.4 | 4.5 |  |
| $t_{\text {PHZ }}$ | $\overline{O E}$ | A | 3.6 | 0.2 | 5.2 | 0.1 | 5.4 | 0.1 | 4.5 | 0.7 | 6 | ns |
| tpLz |  |  | 3.6 | 0.2 | 5.2 | 0.1 | 5.4 | 0.1 | 4.5 | 0.7 | 6 |  |
| tpHz | $\overline{\mathrm{OE}}$ | B | 2.1 | 0.1 | 4.7 | 0.1 | 4.6 | 0.1 | 4.7 | 0.1 | 4.7 | ns |
| $t_{\text {PLZ }}$ |  |  | 2.1 | 0.1 | 4.7 | 0.1 | 4.6 | 0.1 | 4.7 | 0.1 | 4.7 |  |

### 6.10 Switching Characteristics: $\mathrm{V}_{\mathrm{CCA}}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$

over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CCA}}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ (see Figure 3)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $\mathrm{V}_{\mathrm{CCB}}=1.2 \mathrm{~V}$ | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=1.5 \mathrm{~V} \\ \pm 0.1 \mathrm{~V} \end{gathered}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=1.8 \mathrm{~V} \\ \pm 0.15 \mathrm{~V} \end{gathered}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=2.5 \mathrm{~V} \\ \pm 0.2 \mathrm{~V} \end{gathered}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CCB}}=3.3 \mathrm{~V} \\ \pm 0.3 \mathrm{~V} \end{gathered}$ |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | TYP | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX |  |
| $\mathrm{t}_{\text {PLH }}$ | A | B | 1.8 | 0.1 | 3.6 | 0.1 | 3 | 0.1 | 2.6 | 0.1 | 2.4 | ns |
| $\mathrm{t}_{\text {PHL }}$ |  |  | 1.8 | 0.1 | 3.6 | 0.1 | 3 | 0.1 | 2.6 | 0.1 | 2.4 |  |
| $t_{\text {PLH }}$ | B | A | 1.9 | 0.5 | 3.4 | 0.2 | 2.9 | 0.1 | 2.5 | 0.1 | 2.3 | ns |
| $\mathrm{t}_{\text {PHL }}$ |  |  | 1.9 | 0.5 | 3.4 | 0.2 | 2.9 | 0.1 | 2.5 | 0.1 | 2.3 |  |
| tpzH | $\overline{\mathrm{OE}}$ | A | 3.1 | 0.9 | 5.9 | 0.5 | 5 | 0.3 | 3.8 | 0.3 | 3.3 | ns |
| $t_{\text {PZL }}$ |  |  | 3.1 | 0.9 | 5.9 | 0.5 | 5 | 0.3 | 3.8 | 0.3 | 3.3 |  |
| tpzH | $\overline{\mathrm{OE}}$ | B | 1.2 | 0.4 | 3.6 | 0.4 | 3.6 | 0.4 | 3.6 | 0.4 | 3.6 | ns |
| $\mathrm{t}_{\text {PZL }}$ |  |  | 1.2 | 0.4 | 3.6 | 0.4 | 3.6 | 0.4 | 3.6 | 0.4 | 3.6 |  |
| tpHz | $\overline{O E}$ | A | 3.4 | 0.1 | 4.6 | 0.1 | 4.7 | 0.3 | 4.8 | 0.7 | 4.5 | ns |
| tplz |  |  | 3.4 | 0.1 | 4.6 | 0.1 | 4.7 | 0.3 | 4.8 | 0.7 | 4.5 |  |
| $\mathrm{t}_{\text {PHZ }}$ | $\overline{\mathrm{OE}}$ | B | 2.9 | 0.1 | 5.4 | 0.1 | 5.3 | 0.1 | 5.3 | 0.1 | 5.3 | ns |
| $t_{\text {PLZ }}$ |  |  | 2.9 | 0.1 | 5.4 | 0.1 | 5.3 | 0.1 | 5.3 | 0.1 | 5.3 |  |

### 6.11 Operating Characteristics

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| PARAMETER |  |  | TEST CONDITIONS | $\begin{gathered} \mathrm{V}_{\mathrm{CCA}}= \\ \mathrm{V}_{\mathrm{CCB}}=1.2 \mathrm{~V} \end{gathered}$ | $\begin{gathered} \mathrm{V}_{\mathrm{CCA}}= \\ \mathrm{V}_{\mathrm{CCB}}=1.5 \mathrm{~V} \end{gathered}$ | $\begin{gathered} \mathrm{V}_{\mathrm{CCA}}= \\ \mathrm{V}_{\mathrm{CCB}}=1.8 \mathrm{~V} \end{gathered}$ | $\begin{gathered} \mathrm{V}_{\mathrm{CCA}}= \\ \mathrm{V}_{\mathrm{CCB}}=2.5 \mathrm{~V} \end{gathered}$ | $\begin{gathered} \mathrm{V}_{\mathrm{CCA}}= \\ \mathrm{V}_{\mathrm{CCB}}=3.3 \mathrm{~V} \end{gathered}$ | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | TYP | TYP | TYP | TYP | TYP |  |
| $\mathrm{C}_{\mathrm{pdA}}{ }^{(1)}$ | A to B | Outputs enabled |  | $\begin{gathered} \mathrm{C}_{\mathrm{L}}=0, \\ \mathrm{f}=10 \mathrm{MHz}, \\ \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=1 \mathrm{~ns} \end{gathered}$ | 3 | 3 | 3 | 3 | 4 | pF |
|  |  | Outputs disabled | 1 |  | 1 | 1 | 2 | 2 |  |  |
|  | $B$ to $A$ | Outputs enabled | 12 |  | 13 | 13 | 15 | 15 |  |  |
|  |  | Outputs disabled | 1 |  | 2 | 2 | 2 | 2 |  |  |
| $\mathrm{C}_{\mathrm{pdB}}{ }^{(1)}$ | A to B | Outputs enabled | $\begin{gathered} \mathrm{C}_{\mathrm{L}}=0, \\ \mathrm{f}=10 \mathrm{MHz}, \\ \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=1 \mathrm{~ns} \end{gathered}$ | 12 | 13 | 13 | 14 | 16 | pF |  |
|  |  | Outputs disabled |  | 1 | 2 | 2 | 2 | 2 |  |  |
|  | B to A | Outputs enabled |  | 3 | 3 | 3 | 4 | 4 |  |  |
|  |  | Outputs disabled |  | 1 | 1 | 1 | 2 | 2 |  |  |

[^1]
### 6.12 Typical Characteristics



Figure 1. $\mathrm{V}_{\mathrm{OL}}$ Voltage vs $\mathrm{I}_{\mathrm{OL}}$ Current


Figure 2. $\mathrm{V}_{\mathrm{OH}}$ Voltage vs $\mathrm{I}_{\mathrm{OH}}$ Current

## 7 Parameter Measurement Information



| TEST | S1 |
| :---: | :---: |
| $\mathbf{t}_{\text {pd }}$ | Open |
| $\mathbf{t}_{\text {PLZ }} / \mathbf{t}_{\text {PZL }}$ | $2 \cdot \mathbf{V}_{\text {CCO }}$ |
| $\mathbf{t}_{\text {PHZ }} / \mathbf{t}_{\text {PZH }}$ | GND |


| $\mathrm{V}_{\mathrm{CCO}}$ | $\mathrm{C}_{\mathrm{L}}$ | $\mathrm{R}_{\mathrm{L}}$ | $\mathrm{V}_{\mathrm{TP}}$ |
| :---: | :---: | :---: | :---: |
| 1.2 V | 15 pF | $2 \mathrm{k} \Omega$ | 0.1 V |
| $1.5 \mathrm{~V} \pm 0.1 \mathrm{~V}$ | 15 pF | $2 \mathrm{k} \Omega$ | 0.1 V |
| $1.8 \mathrm{~V} \pm 0.15 \mathrm{~V}$ | 15 pF | $2 \mathrm{k} \Omega$ | 0.15 V |
| $2.5 \mathrm{~V} \pm 0.2 \mathrm{~V}$ | 15 pF | $2 \mathrm{k} \Omega$ | 0.15 V |
| $3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ | 15 pF | $2 \mathrm{k} \Omega$ | 0.3 V |



VOLTAGE WAVEFORMS PULSE DURATION


VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES


VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES

NOTES: A. $C_{L}$ includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR $10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega, \mathrm{dv} / \mathrm{dt} \geq 1 \mathrm{~V} / \mathrm{ns}$.
D. The outputs are measured one at a time, with one transition per measurement.
E. $t_{\mathrm{PLH}}$ and $\mathrm{t}_{\mathrm{PHL}}$ are the same as $t_{\mathrm{pd}}$.
F. $\mathrm{V}_{\mathrm{Cl}}$ is the $\mathrm{V}_{\mathrm{CC}}$ associated with the input port.

G . $\mathrm{V}_{\mathrm{CCO}}$ is the $\mathrm{V}_{\mathrm{CC}}$ associated with the output port.
Figure 3. Load and Circuit and Voltage Waveforms

## 8 Detailed Description

### 8.1 Overview

The SN74AVC2T245 is a dual-bit, dual-supply noninverting bidirectional voltage level translation. Pins A and control pins (DIR and OE) are supported by $\mathrm{V}_{\mathrm{CCA}}$ and pins B are supported by $\mathrm{V}_{\mathrm{CcB}}$. The A port can accept $\mathrm{I} / \mathrm{O}$ voltages ranging from 1.2 V to 3.6 V , while the B port can accept $\mathrm{I} / \mathrm{O}$ voltages from 1.2 V to 3.6 V . A high on DIR allows data transmission from $A$ to $B$ and a low on DIR allows data transmission from $B$ to $A$ when $\overline{O E}$ is set to low. When $\overline{\mathrm{OE}}$ is set to high, both A and B are in the high-impedance state.

This device is fully specified for partial-power-down applications using off output current (loff).
The $\mathrm{V}_{\mathrm{CC}}$ isolation feature ensures that if either $\mathrm{V}_{\mathrm{CC}}$ input is at $G N D$, both ports are put in a high-impedance state.

### 8.2 Functional Block Diagram



Figure 4. Logic Diagram (Positive Logic)

### 8.3 Feature Description

### 8.3.1 Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full <br> 1.2 V to 3.6 V Power-Supply Range

Both $\mathrm{V}_{\mathrm{CCA}}$ and $\mathrm{V}_{\mathrm{CCB}}$ can be supplied at any voltage from 1.2 V to 3.6 V making the device suitable for translating between any of the low voltage nodes ( $1.2 \mathrm{~V}, 1.8 \mathrm{~V}, 2.5 \mathrm{~V}$, and 3.3 V ).

### 8.3.2 Partial-Power-Down Mode Operation

This device is fully specified for partial-power-down applications using off output current ( $\mathrm{l}_{\mathrm{off}}$ ). The $\mathrm{I}_{\text {off }}$ circuitry will prevent backflow current by disabling I/O output circuits when device is in partial power-down mode.

### 8.3.3 $\mathrm{V}_{\mathrm{CC}}$ Isolation

The $\mathrm{V}_{\mathrm{CC}}$ isolation feature ensures that if either $\mathrm{V}_{C C A}$ or $\mathrm{V}_{C C B}$ are at $G N D$, both ports will be in a high-impedance state (loz). This prevents false logic levels from being presented to either bus.

### 8.4 Device Functional Modes

The SN74AVC2T245 is a voltage level translator that can operate from1.2 V to $3.6 \mathrm{~V}\left(\mathrm{~V}_{\mathrm{CCA}}\right)$ and 1.2 V to 3.6 V $\left(\mathrm{V}_{\mathrm{CCB}}\right)$. The signal translation requires direction control and output enable control. The table below enlists the operation of the part for the respective states of the control inputs.

Table 1. Function Table ${ }^{(1)}$ (Each Transceiver)

| CONTROL INPUTS |  | OUTPUT CIRCUITS |  | OPERATION |
| :---: | :---: | :---: | :---: | :---: |
| $\overline{\text { OE }}$ | DIR1 | A PORT | B PORT |  |
| L | L | Enabled | $\mathrm{Hi}-\mathrm{Z}$ | B data to A data |
| L | H | $\mathrm{Hi}-\mathrm{Z}$ | Enabled | A data to B data |
| H | X | $\mathrm{Hi}-\mathrm{Z}$ | $\mathrm{Hi}-\mathrm{Z}$ | Isolation |

(1) Input circuits of the data I/Os are always active.

## 9 Application and Implementation

## NOTE

Information in the following applications sections is not part of the Tl component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

The SN74AVC2T45 is used to shift IO voltage levels from one voltage domain to another. Bus A and bus B have independent power supplies, and a direction pin is used to control the direction of data flow. Unused data ports must not be floating; tie the unused port input and output to ground directly.

### 9.1.1 Enable Times

Calculate the enable times for the SN74AVC16T45 using the following formulas:

$$
\begin{align*}
& \mathrm{t}_{\text {PZH }}(\text { DIR to } A)=\mathrm{t}_{\text {PLZ }}(\text { DIR to } B)+\mathrm{t}_{\text {PLH }}(\text { B to } A)  \tag{1}\\
& \mathrm{t}_{\text {PZL }}(\text { DIR to } A)=\mathrm{t}_{\text {PHZ }}(\text { DIR to } B)+\mathrm{t}_{\text {PHL }}(\text { B to } A)  \tag{2}\\
& \left.\mathrm{t}_{\text {PZH }}(\text { DIR to } B)=\mathrm{t}_{\text {PLZ }} \text { (DIR to } A\right)+\mathrm{t}_{\text {PLH }}(\text { A to } B)  \tag{3}\\
& \left.\mathrm{t}_{\text {PZL }}(\text { DIR to })=\mathrm{t}_{\text {PHZ }} \text { (DIR to } A\right)+\mathrm{t}_{\text {PHL }}(\mathrm{A} \text { to } B \tag{4}
\end{align*}
$$

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the SN74AVC2T245 initially is transmitting from A to B, then the DIR bit is switched; the B port of the device must be disabled before presenting it with an input. After the $B$ port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.

### 9.2 Typical Application



Figure 5. Typical Application of the SN74AVC2T245

### 9.2.1 Design Requirements

This device uses drivers which are enabled depending on the state of the DIR pin. The designer must know the intended flow of data and take care not to violate any of the high or low logic levels. Unused data inputs must not be floating, as this can cause excessive internal leakage on the input CMOS structure. Tie any unused input and output ports directly to ground.
For this design example, use the parameters listed in Table 2.

Table 2. Design Parameters

| DESIGN PARAMETER | EXAMPLE VALUE |
| :---: | :---: |
| Input voltage range | 1.2 V to 3.6 V |
| Output voltage range | 1.2 V to 3.6 V |

### 9.2.2 Detailed Design Procedure

To begin the design process, determine the following:

### 9.2.2.1 Input Voltage Ranges

Use the supply voltage of the device that is driving the SN74AVC2T245 device to determine the input voltage range. For a valid logic high the value must exceed the $\mathrm{V}_{I H}$ of the input port. For a valid logic low the value must be less than the $\mathrm{V}_{\text {IL }}$ of the input port.

### 9.2.2.2 Output Voltage Range

Use the supply voltage of the device that the SN74AVC2T245 device is driving to determine the output voltage range.

### 9.2.3 Application Curves



Figure 6. 3.3 V to 1.8 V Level-Shifting With 1-MHz Square Wave

## 10 Power Supply Recommendations

The SN74AVC2T245 device uses two separate configurable power-supply rails, $\mathrm{V}_{\text {CCA }}$ and $\mathrm{V}_{\text {CCB }}$. $\mathrm{V}_{\text {CCA }}$ accepts any supply voltage from 1.2 V to 3.6 V and $\mathrm{V}_{\mathrm{CCB}}$ accepts any supply voltage from 1.2 V to 3.6 V . The A port and $B$ port are designed to track $\mathrm{V}_{\mathrm{CCA}}$ and $\mathrm{V}_{\mathrm{CCB}}$ respectively allowing for low-voltage bidirectional translation between any of the $1.2 \mathrm{~V}, 1.5 \mathrm{~V}, 1.8 \mathrm{~V}, 2.5 \mathrm{~V}, 3.3 \mathrm{~V}$ and 5 V voltage nodes.

## 11 Layout

### 11.1 Layout Guidelines

To ensure reliability of the device, following common printed-circuit-board layout guidelines is recommended.

- Bypass capacitors should be used on power supplies.
- Short trace lengths should be used to avoid excessive loading.
- Placing pads on the signal paths for loading capacitors or pullup resistors to help adjust rise and fall times of signals depending on the system requirements.


### 11.2 Layout Example



Figure 7. Recommended Layout Example

## 12 Device and Documentation Support

### 12.1 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2ETM Online Community TI's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.
Design Support TI's Design Support Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 12.2 Trademarks

E2E is a trademark of Texas Instruments.
All other trademarks are the property of their respective owners.

### 12.3 Electrostatic Discharge Caution

These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam
during storage or handling to prevent electrostatic damage to the MOS gates.

### 12.4 Glossary

SLYZ022 - TI Glossary.
This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable Device | Status <br> (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <br> (2) | Lead finish/ Ball material (6) | MSL Peak Temp <br> (3) | Op Temp ( ${ }^{\circ} \mathrm{C}$ ) | Device Marking <br> (4/5) | Samples |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN74AVC2T245RSWR | ACtive | UQFN | RSW | 10 | 3000 | RoHS \& Green | NIPDAU \| NIPDAUAG | Level-1-260C-UNLIM | -40 to 85 | ```(TQ7, TQO, TQR, TQ V) (TQH, TQJ, TQY) (VCH, VCO) (VCJ, VCR)``` | Samples |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption
Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.
${ }^{(3)}$ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
${ }^{(4)}$ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device
${ }^{(5)}$ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
${ }^{(6)}$ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width

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TAPE AND REEL INFORMATION

*All dimensions are nominal

| Device | Package <br> Type | Package <br> Drawing | Pins | SPQ | Reel <br> Diameter <br> $(\mathbf{m m})$ | Reel <br> Width <br> $\mathbf{W 1}(\mathbf{m m})$ | A0 <br> $(\mathbf{m m})$ | B0 <br> $(\mathbf{m m})$ | K0 <br> $(\mathbf{m m})$ | P1 <br> $(\mathbf{m m})$ | W <br> $(\mathbf{m m})$ | Pin1 <br> Quadrant |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN74AVC2T245RSWR | UQFN | RSW | 10 | 3000 | 180.0 | 9.5 | 1.6 | 2.0 | 0.8 | 4.0 | 8.0 | Q1 |
| SN74AVC2T245RSWR | UQFN | RSW | 10 | 3000 | 180.0 | 9.5 | 1.6 | 2.0 | 4.0 | 4.0 | 8.0 | Q1 |
| SN74AVC2T245RSWR | UQFN | RSW | 10 | 3000 | 180.0 | 8.4 | 1.59 | 2.09 | 0.72 | 4.0 | 8.0 | Q1 |

PACKAGE MATERIALS INFORMATION

*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN74AVC2T245RSWR | UQFN | RSW | 10 | 3000 | 189.0 | 185.0 | 36.0 |
| SN74AVC2T245RSWR | UQFN | RSW | 10 | 3000 | 184.0 | 184.0 | 19.0 |
| SN74AVC2T245RSWR | UQFN | RSW | 10 | 3000 | 202.0 | 201.0 | 28.0 |



NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package complies to JEDEC MO-288 variation UDEE, except minimum package height.


NOTES: (continued)
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271)
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.


SOLDER PASTE EXAMPLE BASED ON 0.125 MM THICK STENCIL SCALE: 30X

NOTES: (continued)
6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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[^0]:    (1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report, SPRA953.

[^1]:    (1) Power dissipation capacitance per transceiver. Refer to the TI application report, CMOS Power Consumption and Cpd Calculation, SCAA035

